



Docket No.: M4065.0239/P239
(PATENT)

Ep 2811

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Larry Hillyer, et al.

Application No.: 09/653,561

Group Art Unit: 2811

Filed: August 31, 2000

Examiner: S. Clark

For: METHOD AND MATERIAL FOR
REMOVING ETCH RESIDUE FROM HIGH
ASPECT RATIO CONTACT SURFACES

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents
Washington, DC 20231

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Dear Sir:

In response to the restriction requirement set forth in the Office Action mailed November 6, 2001, Applicants hereby provisionally elect Group I (i.e., claims 1-44 and 50-53) for continued examination, without traverse.

The claims of this application are believed to be in immediate condition for allowance. Applicants respectfully solicit an office action on the merits and, subsequently, the allowance of at least claims 1-44 and 50-53.

Dated: November 21, 2001

Respectfully submitted,

By 

Thomas J. D'Amico

Registration No.: 28,371

Ryan H. Flax

Registration No.: 48,141

DICKSTEIN SHAPIRO MORIN &

OSHINSKY LLP

2101 L Street NW

Washington, DC 20037-1526

(202) 828-2232

Attorneys for Applicants